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THIS DRA FOR USE E	MILITARY DRAWING  THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE  20 JANUARY 1989						512X Size	8, 1	PROM	, MOI	ODE	THI	c s:	ILIC	ON	-88		Ю							
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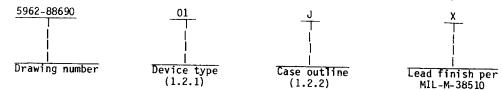
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1	SC	ODE
	- 51.4	JPF

1.1~Scope. This drawing describes device requirements for class B microcircuits in accordance with  $1.\overline{2.1}$  of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device types. The device types shall identify the circuit function as follows:

Device type	Generic number	Circuit function	Access time
01	(See 6.4)	512 X 8 CMOS PROM	220 ns
02	(See 6.4)	512 X 8 CMOS PROM	140 ns

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline
J	D-3 (24-lead, 1.290" x .610" x .225"), dual-in-line package
L	D-9 (24-lead, 1.280" x .310" x .200"), dual-in-line package
3	C-4 (28-terminal, .460" x .460" x .100"), square chip carrier package

1.3 Absolute maximum ratings.

1.4 Recommended operating conditions.

1/ Maximum junction temperature may be increased to +175°C during burn-in and steady-state life.

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## 2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

- Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

## REQUIREMENTS

- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of  ${\sf MIL-STD-883}$ , "Provisions for the use of  ${\sf MIL-STD-883}$  in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
  - 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
  - 3.2.2 Truth table. The truth table shall be as specified on figure 2.
- 3.2.2.1 Unprogrammed devices. The truth table for unprogrammed devices for contracts involving no altered item drawing shall be as specified on figure 2. When required in groups A, B, or C inspection (see 4.3), the devices shall be programmed by the manufacturer prior to test in a checkerboard pattern (a minimum of 50 percent of the total number of bits programmed) or to any altered item drawing pattern which includes at least 25 percent of the total number of bits programmed.
- 3.2.2.2 Programmed devices. The requirements for supplying programmed devices are not part of this drawing.
  - 3.2.3 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.

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	TABLE	I. Electrical performance	e charac	teristics	•			
Test	Symbol	Conditions		Group A	Device	Li	mits	Unit
	 	$ \begin{array}{c c} & \text{Conditions} \\ & -55^{\circ}\text{C} < \text{T}_{\text{C}} < +125^{\circ} \\ & \text{V}_{\text{CC}} = 4.5 \text{ Y} \text{ to } 5.5 \\ & \text{unless otherwise spec} \\ \end{array} $	ν ified <u>1</u> /	subgroups     	types   	Min	Max	]    -
Output high voltage	V <sub>OH</sub>	V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -1.0 mA	1,2,3	I I I	2.4		! γ !	
Output low voltage	VOL	$V_{CC} = 4.5 \text{ V}, I_{OL} = 3.2 \text{ m}$	1,2,3	I I I	1	0.4	   V	
Input leakage current (except P input)	II	V <sub>CC</sub> = 5.5,  0 V < VIN < 5.5 V	1,2,3	   A11 	1-1.0	1.0	μА	
Output leakage current, high impedance	Ioz	$ V_{CC} = 5.5 \text{ V}, \ G = 5.5 \text{ V}, \  GND \leq V_{I/O} \leq V_{CC} $	1,2,3	   A7 1 	  -1.0 	1.0	μА	
Operating supply current	Icc	$V_{CC} = 5.5 \text{ V}, \overline{G} = V_{CC},$ $V_{OUT} = 0 \text{ mA}, f = 1 \text{ MHz}$ $V_{OUT} = 0 \text{ MA}, f = 1 \text{ MHz}$	1,2,3	ATT	     	20	mΑ	
Standby supply current	I I SB	$V_{CC} = 5.5 \text{ V}, I_{QUT} = 0 \text{ mA}$	,	1,2,3	All		100	μА
Input capacitance	J i	V <sub>CC</sub> = open, f = 1.0 MHz,	Case J	4	A] ]		10	
		referenced to device	Case L	 	 		13	pF
	1	ground		    	! !	1	8.0	
Input/output capacitance		f = 1.0  MHz	Case J	4	A11	1	12	
		T <sub>A</sub> = +25°C, see 4.3.1c, All measurements are referenced to device ground	Case L	 	 	1	15	pF
Ĭ	İ	<b>y</b> ,	Case 3	!	į	[	10	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued. Test Symbol | Conditions | Group A | Device Limits Unit  $-55^{\circ}C < T_{C} < +125^{\circ}C$   $Y_{CC} = 4.5$  V to 5.5 V unless otherwise specified 1/1subgroups types Min Max Address access time |See figures 3 and 4 tAVQV 9,10,11 220 ns 02 140 Output enable access 9,10,11 01 150 tgvqv l ns 02 50 Chip enable access time |teloy 9,10,11 01 200 ns 02 120 Address setup time 9,10,11 tAVEL 01 20 ns 02 20 Address hold time 9,10,11 01 60 ItELAX ns 02 Chip enable low pulse 9,10,11 01 200 tELEH ns 02 120 Chip enable high pulse 9,10,11 | teHEL 01 150 ns 02 40 See footnotes at end of table. **STANDARDIZED** SIZE A **MILITARY DRAWING** 5962-88690 **DEFENSE ELECTRONICS SUPPLY CENTER REVISION LEVEL** SHEET DAYTON, OHIO 45444 5

Test	Symbol	Conditions	Group A	Device types	Lir	Unit	
	l I	Conditions $-55^{\circ}C < T_C < +125^{\circ}C$ $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ unless otherwise specified $1/$	subgroups		Min     Min   	Max	!   
Read cycle time	t <sub>ELEL</sub>	See figures 3 and 4 2/	9,10,11	01	1350		l ns
	<u> </u>			02	1160		] ] ]
Output enable time	t <sub>G</sub> vQx	' [ 	9,10,11	01	5.0	150	l ns
	<u>3/</u>	] 	1 !	02	5.0	50	
Output disable time	t <sub>GXQZ</sub>	] 	9,10,11	01		150	nc
	3/		İ	02	<del>                                     </del>	50	ns

- $\underline{1}/$  All measurements are performed with P hardwired to GND. See 6.4  $\underline{2}/$ .
- 2/ Test conditions assume signal transition times of 5.0 ns or less. Timing is referenced at input and output levels of 1.5 V and input pulse levels of 0 to 3.0 V. Output loading is  $I_{OL}$  = +1.0 mA and  $I_{OH}$  = -1.0 mA with a load capacitance of 50 pF.
- $\underline{3}/$  If not tested, shall be guaranteed to limits specified in table I.

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Device types	A11					
Case outlines	J and L	3				
Terminal number	Terminal	symbol .				
1 2 3 4 5 5 6 6 7 7 8 9 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28	A7 A6 A5 A4 A3 A2 A1 Q0 Q1 Q2 G0 Q3 Q4 Q5 Q6 Q7 PE G3 G2 G1 A8 VC	NC 766543210C 012D C 34567C PE 32T 8CC NC 967C NC 982C A8YCC				

FIGURE 1. Terminal connections.

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		Input	s	Outputs					
Time reference   (See figure 5)	E	G	A	Q.	Function				
-1	Н	H	X	Z	Memory disabled				
0	<u>-</u> -	H	v	l z	  Cycle begins-addresses are latched				
1	L	   L	X	l x	  Output enabled				
2	L	[   L	x	   V	Output valid				
3	_ _	L	X	l v	Output latched				
4	н	Н	х	Z	  Read accomplished and output disabled				
5	н	н	Х	Z	  Prepare for next cycle (same as -1)				
   6 	_l_	н	X	Z	  Cycle ends, next cycle begins (same as O)  				

H = Logic high voltage level

L = Logic low voltage level

Z = High impedance state

X = Don't care

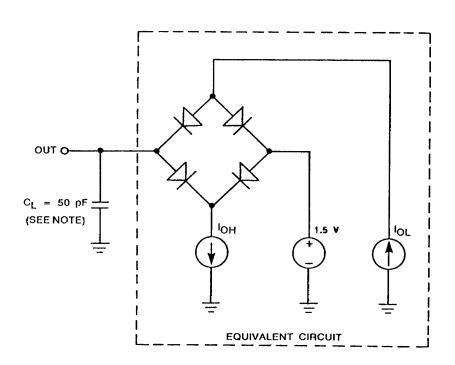
1\_ = High-to-low transition

 $_{l}^{-}$  = Low-to-high transition

V = Valid

FIGURE 2. Truth table (unprogrammed).

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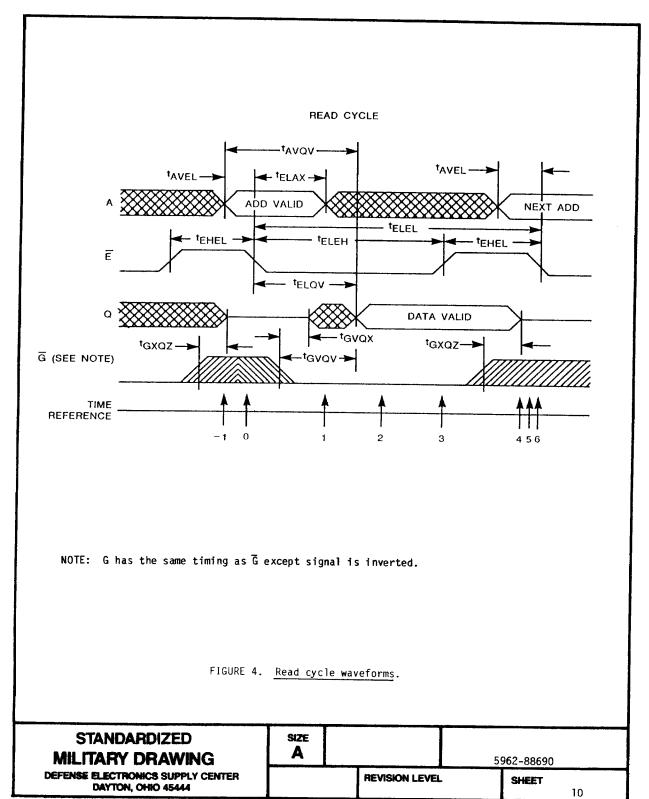


NOTE:  $C_L$  = Load capacitance and includes scope and jig capacitance.

FIGURE 3. Output load circuit or equivalent.

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- 3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.
- 3.5 Processing options. Since the PROM is an unprogrammed memory capable of being programmed by either the manufacturer or the user to result in a wide variety of PROM configurations, two processing options are provided for selection in the contract, using an altered item drawing.
- 3.5.1 Unprogrammed PROM delivered to the user. All testing shall be verified through group A testing as defined in 4.3.1. It is recommended that users perform subgroups 7 and 9 after programming to verify the specific program configuration.
- 3.5.2 Manufacturer-programmed PROM delivered to the user. All testing requirements and quality assurance provisions herein, including the requirements of the altered item drawing shall be satisfied by the manufacturer prior to delivery.
- 3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.9 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
  - a. Burn-in test, method 1015 of MIL-STD-883.
    - (1) Test condition C or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
    - (2)  $T_A = +125$ °C, minimum.
  - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

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- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method  $\overline{5005}$  of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
  - 4.3.1 Group A inspection.
    - a. Tests shall be as specified in table II herein.
    - b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
    - c. Subgroup 4 ( $C_{IN}$  and  $C_{OUT}$  measurements) shall be measured only for the initial characterization and after process or design changes which may affect capacitance. Sample size is fifteen devices with no failures, and all input and output terminals tested.
    - d. Unprogrammed devices shall be tested for programmability and ac performance compliance to the requirements of group A, subgroups 9, 10, and 11.
      - (1) A sample shall be selected to satisfy programmability requirements prior to performing subgroup 9. Twelve devices shall be submitted to programming (see 3.2.2.1). If more than two devices fail to program, the lot shall be rejected. At the manufacturers option, the sample may be increased to 24 total devices with no more than four total device failures allowable.
      - (2) Ten devices from the programmability sample shall be submitted to the requirements of group A, subgroup 9, 10, 11. If more than two devices fail, the lot shall be rejected. At the manufacturer's option, the sample may be increased to 20 total devices with no more than four total device failures allowable.
    - e. Subgroups 7 and 8 must verify the truth table as specified on figure 2 herein.
  - 4.3.2 Groups C and D inspections.
    - a. End-point electrical parameters shall be as specified in table II herein.
    - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
      - (1) Test condition C or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
      - (2)  $T_A = +125$ °C, minimum.
      - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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	TABLE II. Electrical test	requirements.
	MIL-STD-883 test requirements	Subgroups     Subgroups     (per method     5005, table I)
	Interim electrical parameters (method 5004)	
	Final electrical test parameters (method 5004) for unprogrammed devices	
	Final electrical test parameters (method 5004) for programmed devices	1*,2,3,7,8A,8B, 9,10,11
	Group A test requirements (method 5005)	   1,2,3,4**,7,8A,8B,1   9,10,11
	Groups C and D end-point	2,3,7,8

<sup>\*</sup> PDA applies to subgroup 1.

electrical parameters (method 5005)

- 4.4 <u>Programming procedures</u>. The programming procedures shall be as specified by the device manufacturer.
- 4.5 Electrostatic discharge sensitivity (ESDS). Electrostatic discharge sensitivity (ESDS) testing shall be performed in accordance with MIL-STD-883, method 3015 and MIL-M-38510 for initial testing and after any design or process changes which may affect input or output protection circuitry. The option to categorize devices as ESD sensitive without performing the test is not allowed. Only those device types that pass ESDS testing at 1000 volts or greater shall be considered as conforming to the requirements of this drawing.
  - 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
  - 6. NOTES
- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone  $\overline{513-296-5375}$ .

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<sup>\*\*</sup> See 4.3.1c.

6.4 Approved source of supply. An approved source of supply is listed herein. Additional sources will be added as they become available. The vendor listed herein has agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to DESC-ECS.

Military drawing     part number	Vendor CAGE number	Vendor   similar part   number 2/	1
5962-8869001JX	34371	HM1-6642/883	1111
5962-8869001LX	34371	HM6-6642/883	
5962-88690013X	34371	HM4-6642/883	
5962-8869002JX	34371	HM1-6642B/883	
5962-8869002LX	34371	HM6-6642B/883	
5962-88690023X	34371	HM4-6642B/883	

1/ Caution. Do not use this number for item acquisition.

Items acquired to this number may not satisfy the performance requirements of this drawing.

2/ Harris Semiconductor 6642 series, fuse link proms require that program pin P be hardwired to GND except for programming.

Vendor CAGE	Vendor name	Programming	Fusible
number	and address	procedure	link
34371	Harris Semiconductor P. O. Box 883 Melbourne, FL 32901	Α	Nichrome

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